

MOSFET

OptiMOS[™]5 Power-Transistor, 60 V

Features

- Ideal for high-frequency switching
 Optimized for charger
 100% avalanche tested
 Superior thermal resistance

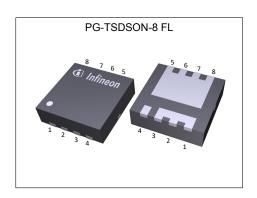
- N-channel, logic level
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
 Qualified for standard grade applications

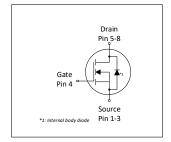
Product validation

Qualified according to JEDEC Standard

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
$V_{ t DS}$	60	V
$R_{ extsf{DS(on)}, ext{max}}$	4.5	mΩ
I D	86	A
Qoss	25	nC
Q _G (0V4.5V)	15	nC











Type / Ordering Code	Package	Marking	Related Links
ISZ0702NLS	PG-TSDSON-8 FL	0702NL	-

OptiMOS[™]5 Power-Transistor, 60 V



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Downwooden	Comple of	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	-	86 61 17	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 °C/W ²⁾
Pulsed drain current ³⁾	$I_{D,pulse}$	-	-	344	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	70	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	65 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²)
Operating and storage temperature	perature T_{j} , T_{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

2 Thermal characteristics

Table 3 **Thermal characteristics**

Parameter	Cumbal	Values	Values		Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	1.7	2.3	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	°C/W	-
Device on PCB, 6 cm² cooling area²)	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOS[™]5 Power-Transistor, 60 V ISZ0702NLS



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter.	0		Value			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	1.1	1.6	2.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=26\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	3.9 4.9	4.5 5.6	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =4.5 V, I _D =10 A
Gate resistance ¹⁾	R _G	-	1.8	-	Ω	-
Transconductance	g fs	-	66	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 A$

Table 5 Dynamic characteristics

Davamatav	Crossball	Values			11:4	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	1900	2500	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	410	530	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	20	27	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	7.5	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	7.6	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	20	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	5.3	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Oh a l		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	5.0	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	3.0	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate to drain charge	$Q_{ m gd}$	-	4.8	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q_{sw}	-	6.7	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	15	20	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.6	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Q_{g}	-	29	39	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Output charge	Q _{oss}	-	25	-	nC	V _{DS} =30 V, V _{GS} =0 V

Defined by design. Not subject to production test.
See "Gate charge waveforms" for parameter definition

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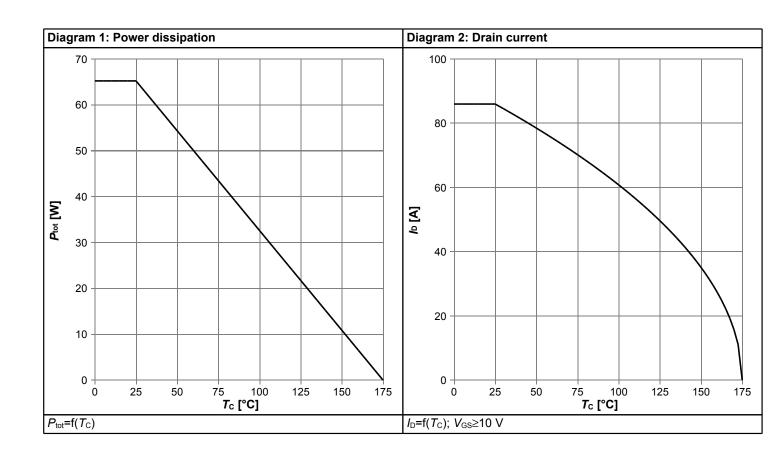


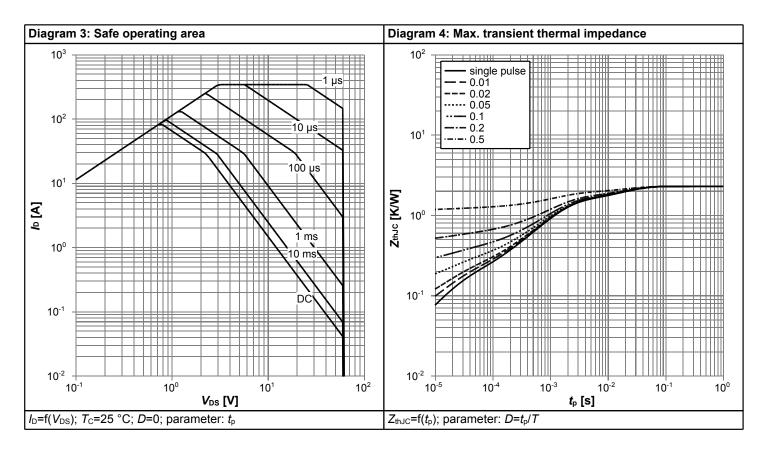
Table 7 Reverse diode

Parameter	Cymphol		Values			Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	57	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	344	Α	T _C =25 °C
Diode forward voltage V_{SD}		-	0.83	1	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	26	-	ns	V _R =30 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	17	-	nC	V _R =30 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

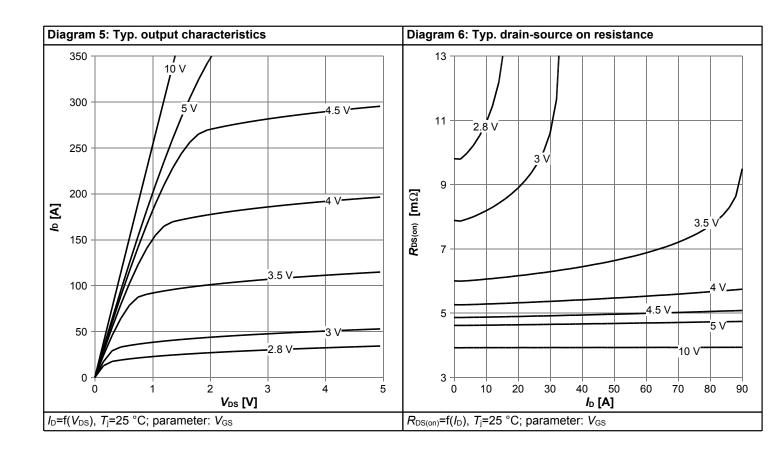


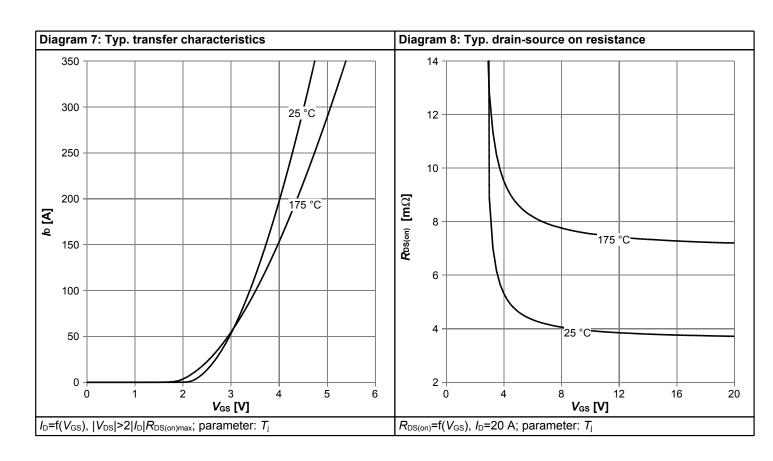
4 Electrical characteristics diagrams



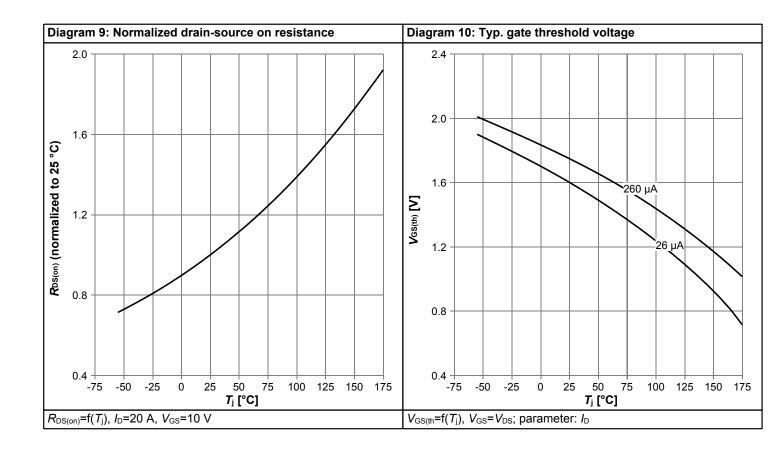


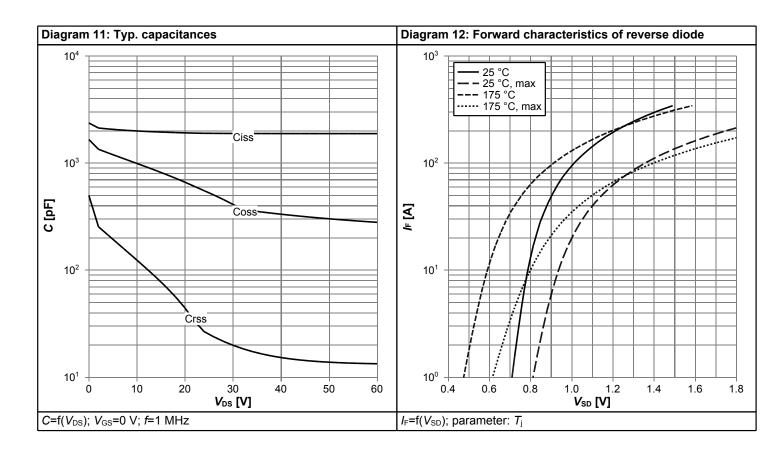




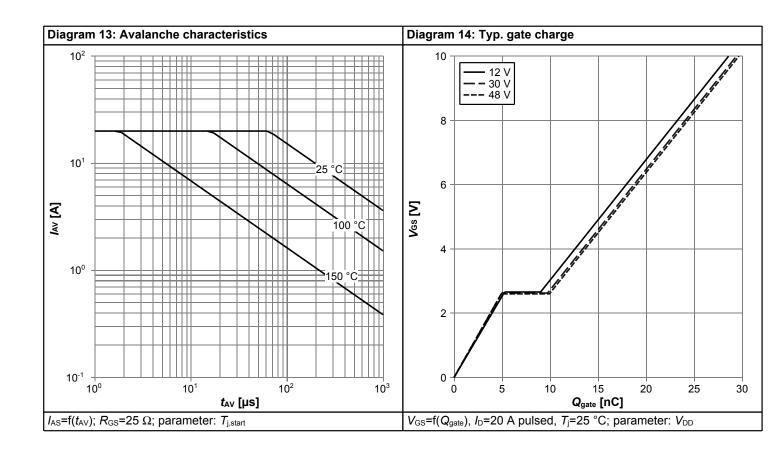


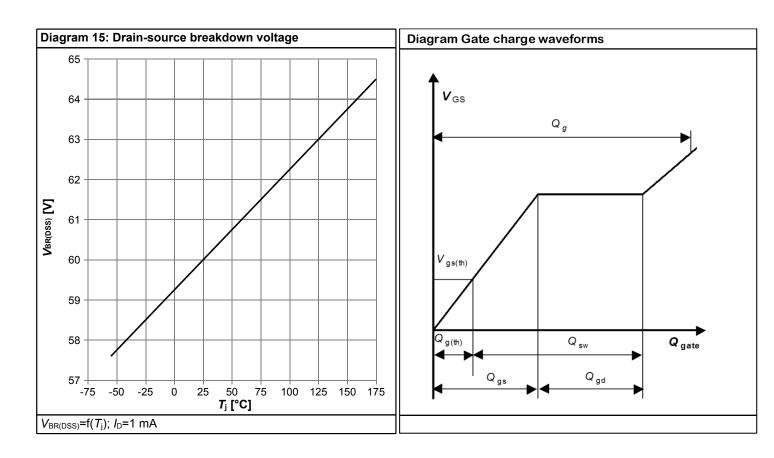






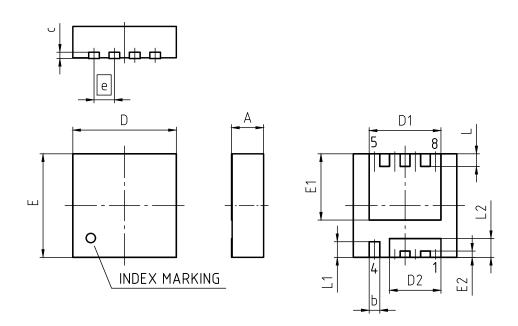








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSDS	SON-8-U03		
REVISION: 03	DATE:	20.10.2020		
DIMENSIONS	MILLIN	IETERS		
DIMENSIONS	MIN.	MAX.		
Α	0.90	1.10		
b	0.24	0.44		
С	(0	.20)		
D	3.20	3.40		
D1	2.19	2.39		
D2	1.54	1.74		
E	3.20	3.40		
E1	2.01	2.21		
E2	0.10	0.30		
е	0.65			
L	0.30	0.50		
L1	0.40	0.60		
L2	0.50	0.70		
aaa	0.0	06		

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm

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Revision History

ISZ0702NLS

Revision: 2021-03-15, Rev. 2.0

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2021-03-15	Release of final version				

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